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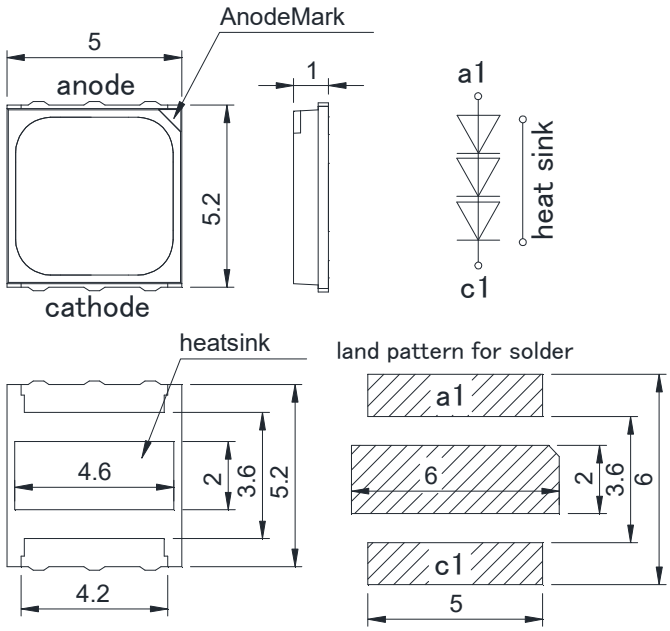
Data Sheet

PRELIMINARY

SMBB940DS-3100S-I

940nm High Power TOP LED

Outline and Internal Circuit



(Unit : mm)

Features

· Chip Material : AlGaAs

· Chip Dimension : 1000um * 1000um

· Number of Chips : 3pcs

· Peak Wavelength : 940nm typ.

· Lead Frame Die : Silver Plated on Copper

· Package Resin : PA9T

· Lens : Silicone Resin

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Absolute Maximum Ratings (Tc=25°C)

Item	Symbol	Ratings	Unit
Power Dissipation	PD	12	W
Forward Current	IF	1000	mA
Pulse Forward Current	IFP	(5000)	mA
Reverse Voltage	VR	15	V
Thermal Resistance	Rthja	5	K/W
Junction Temperature	Tj	130	°C
Operating Temperature	Topr	-40 ~ +100	°C
Storage Temperature	Tstg	-40 ~ +100	°C
Soldering Temperature	TSOL	250	°C

‡Pulse Forward Current condition : Duty 1% and Pulse Width=10us.

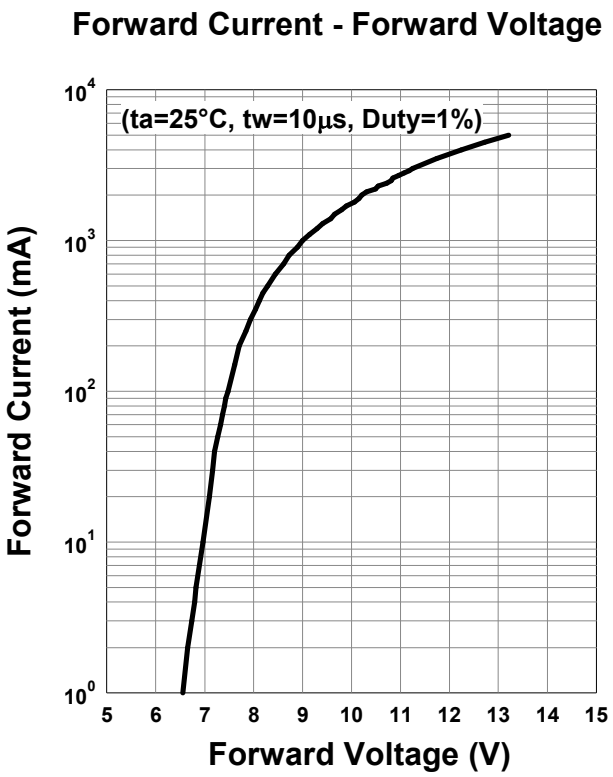
‡Soldering condition : Soldering condition must be completed with 5 seconds at 250°C.

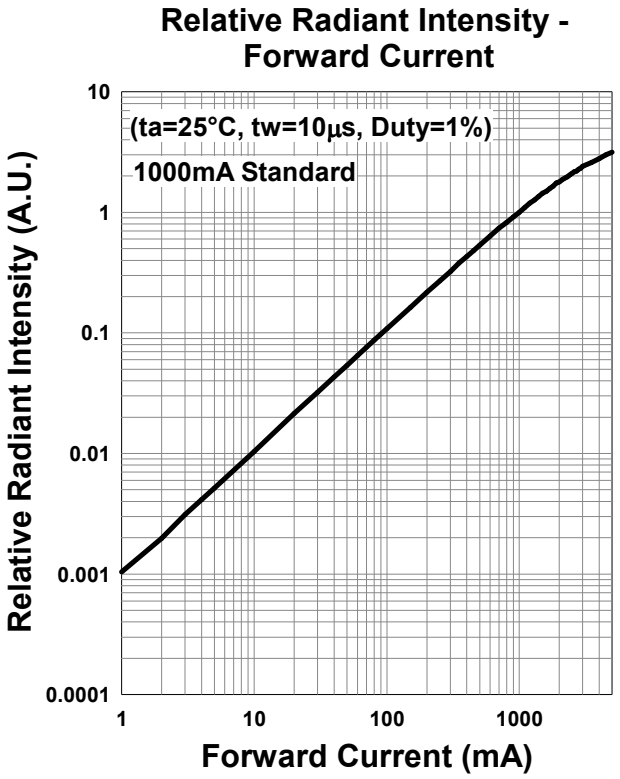
Optical and Electrical Characteristics (Tc=25°C)

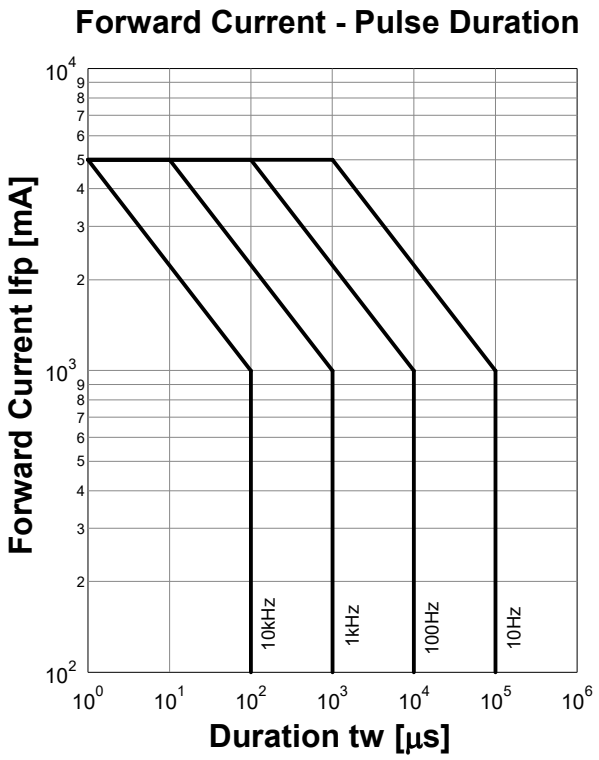
Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage	VF		9.0	(11.4)	V	IF=1A
	VFP		11			IFP=3A
Total Radiated Power	PO		3200		mW	IF=1A
			7600			IFP=3A
Peak Wavelength	λp	930		950	nm	IF=1A
Half Width	Δλ		47		nm	IF=1A
Rise Time	tr		10		ns	IF=1A
Fall Time	tf		15		ns	IF=1A

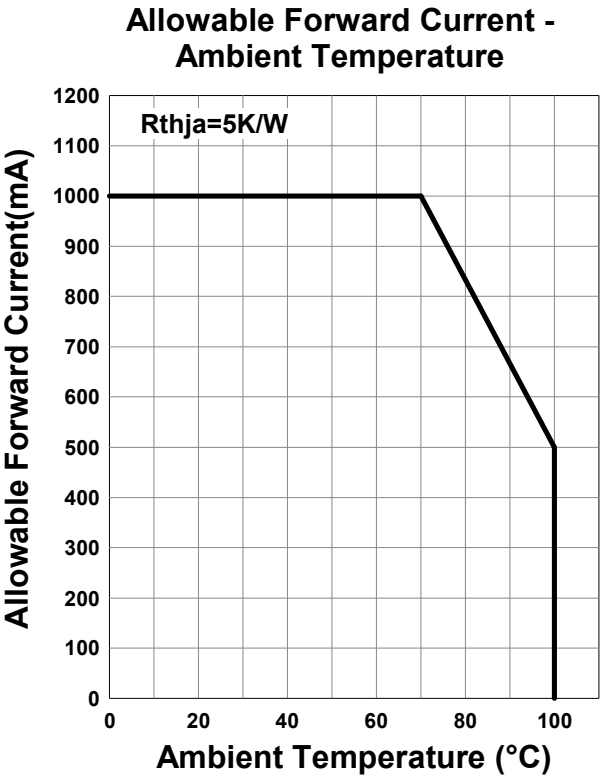
‡ Radiated Power is measured by S3584-08.

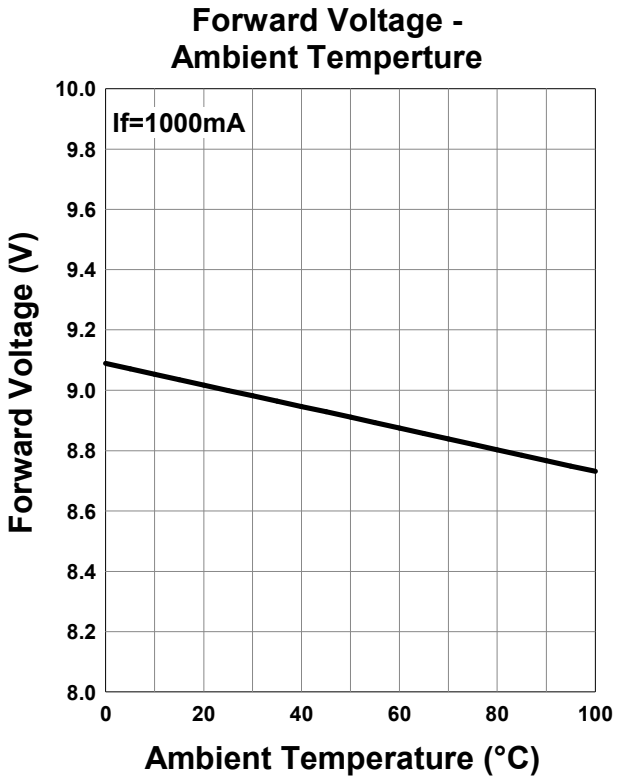
Typical Characteristic Curves

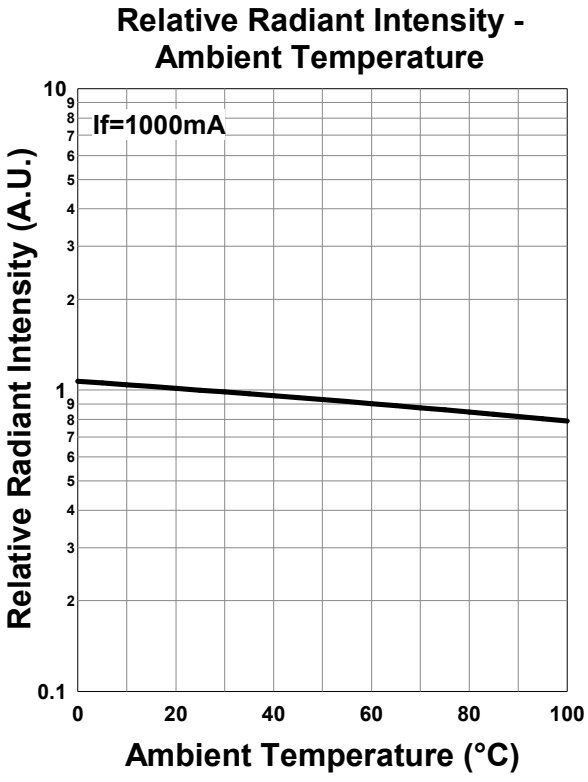


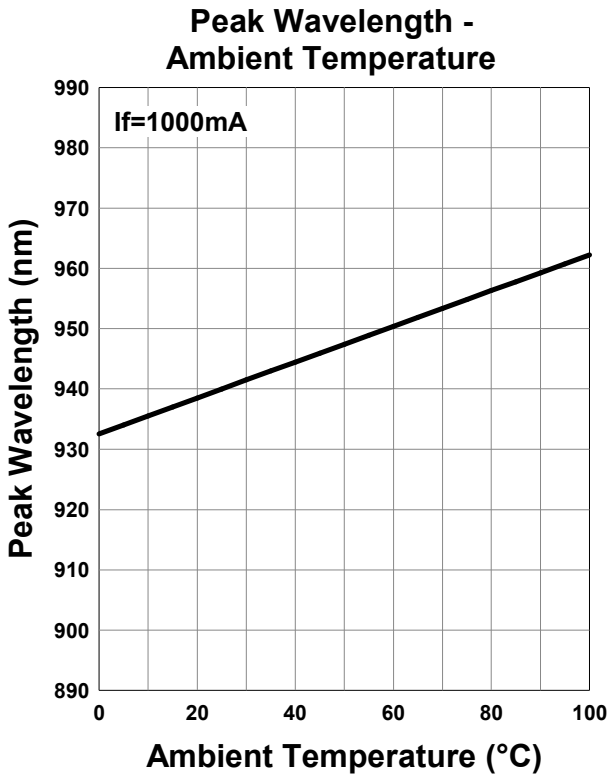


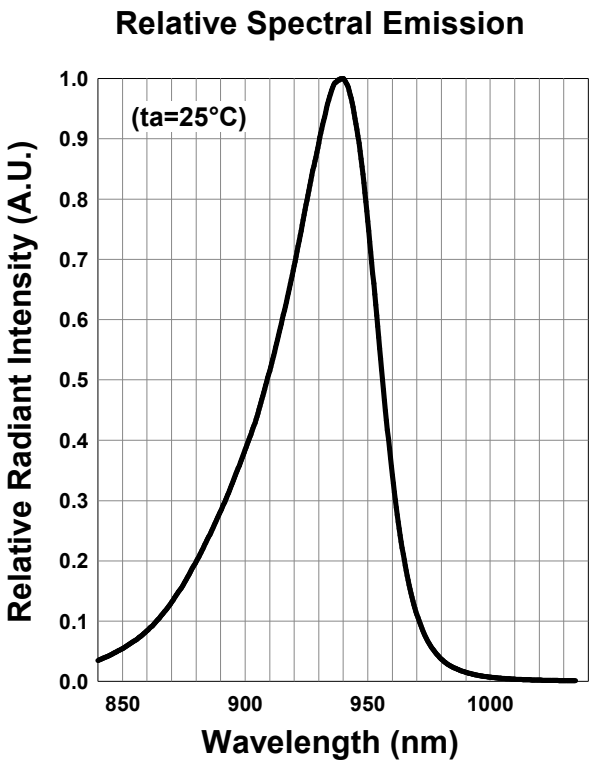





Forward Voltage -
Ambient Temperture
If=1000mA
Forward Voltage (V)
10.0
9.8
9.6
9.4
9.2
9.0
8.8
8.6
8.4
8.2
8.0
0
20
40
60
80
100
Ambient Temperature (°C)


Relative Radiant Intensity -
Ambient Temperature
If=1000mA
Relative Radiant Intensity (A.U.)
10
1
0.1
0
20
40
60
80
100
Ambient Temperature (°C)


Peak Wavelength -
Ambient Temperature
If=1000mA
Peak Wavelength (nm)
990
980
970
960
950
940
930
920
910
900
890
0
20
40
60
80
100
Ambient Temperature (°C)


Relative Spectral Emission
(ta=25°C)
Relative Radiant Intensity (A.U.)
1.0
0.9
0.8
0.7
0.6
0.5
0.4
0.3
0.2
0.1
0.0
850
900
950
1000
Wavelength (nm)

Wrapping

Moisture barrier bag aluminum laminated film with a desiccant to keep out the moisture absorption during the transportation and storage.

SMD LED storage and handling precautions

Storage Conditions before Opening a Moisture-Barrier Aluminum Bag

- Before opening a moisture-barrier aluminum bag, please store it at <30ºC, <60%RH.
- Please note that the maximum shelf life is 12 months under these conditions.

Storage Conditions after Opening a Moisture-Barrier Aluminum Bag

- After opening a moisture-barrier aluminum bag, store the aluminum bag and silica gel in a desiccator.
- After opening the bag, please solder the LEDs within 72 hours in a room with 5 - 30ºC, <50%RH.
- Please put any unused, remaining LEDs and silica gel back in the same aluminum bag and then vacuum-seal the bag.
- It is recommended to keep the re-sealed bag in a desiccator at <30%RH.

- The 72-hour- long floor life does not include the time while LEDs are stored in the moisture-barrier aluminum bag. However, we strongly recommend to solder the LEDs as soon as possible after opening the aluminum bag

Notes about Re-sealing a Moisture-Barrier Aluminum Bag

- When vacuum-sealing an opened aluminum bag, if you find the moisture-indicator of the silica gel has changed to pink from blue (indicating a relative humidity of 30 % or more), please do not use the unused LEDs, the aluminum bag, or the silica gel.

Notes about Opening a Re-sealed Moisture-Barrier Aluminum Bag

- When opening a vacuumed and re-sealed aluminum bag in order to use the remaining LEDs stored in the bag, if you find that the moisture-indicator of the silica has changed to pink, please do not use the LEDs.

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Disclaimer

Product specifications and data shown in this product catalog are subject to change without notice for the purposes of improving product performance, reliability, design, or otherwise.

Product data and parameters in this catalog are typical values based on reasonably up-to-date measurements. Product data and parameters may vary by user application and over time.

Products shown in this catalog are intended to be used for general electronic equipment. Products are not guaranteed for applications where product malfunction or failure may cause personal injury or death, including but not limited to life-supporting / saving devices, medical devices, safety devices, airplanes, aerospace equipment, automobiles, traffic control systems, and nuclear reactor control systems.

The product is manufactured by USHIO Inc. and the spec information is also from USHIO Inc.

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